Low-power dual 2-input EXCLUSIVE-OR gate Rev. 8 — 24 January 2013

Product data sheet

General description 1.

The 74AUP2G86 provides the dual 2-input EXCLUSIVE-OR function.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using IOFF. The IOFF circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



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3. Ordering information

Table 1. Ordering	g information			
Type number	Package			
	Temperature range	Name	Description	Version
74AUP2G86DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74AUP2G86GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm	SOT833-1
74AUP2G86GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1 \times 0.5 mm	SOT1089
74AUP2G86GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2
74AUP2G86GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2
74AUP2G86GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm	SOT1116
74AUP2G86GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1.0 \times 0.35 mm	SOT1203

4. Marking

Table 2.Marking codes

5	
Type number	Marking code ^[1]
74AUP2G86DC	p86
74AUP2G86GT	p86
74AUP2G86GF	рН
74AUP2G86GT	p86
74AUP2G86GM	p86
74AUP2G86GN	рН
74AUP2G86GS	рН

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



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6. Pinning information



6.1 Pinning



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6.2 Pin description

Symbol	Pin		Description	
	SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2		
1A, 2A	1, 5	7, 3	data input	
1B, 2B	2, 6	6, 2	data input	
GND	4	4	ground (0 V)	
1Y, 2Y	7, 3	1, 5	data output	
V _{CC}	8	8	supply voltage	

7. Functional description

Table 4. Function table^[1]

Input		Output
nA	nB	nY
L	L	L
L	Н	Н
Н	L	Н
н	Н	L

[1] H = HIGH voltage level;

L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±20	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.

For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

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9. Recommended operating conditions

Table 6.	Operating conditions				
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 0.8 V$ to 3.6 V	0	200	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 imes V_{CC}$; -	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 imes V_{CC}$; -	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_{O} = –20 $\mu A;$ V_{CC} = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$; -	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		I_{O} = -1.9 mA; V_{CC} = 1.65 V	1.32	-	-	V
		I_{O} = -2.3 mA; V_{CC} = 2.3 V	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3\times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.31	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.44	V

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At recommended operating conditions; voltages are referenced to GND (ground = 0 V). Symbol Parameter Conditions Min Max Unit Тур $V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V ±0.1 h. input leakage current μA -power-off leakage current V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V ±0.2 **I**OFF -μΑ additional power-off V_{I} or $V_{O} = 0$ V to 3.6 V; ±0.2 ΔI_{OFF} μΑ _ - $V_{CC} = 0 V \text{ to } 0.2 V$ leakage current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ 0.5 I_{CC} supply current μA $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ $V_I = V_{CC} - 0.6 V; I_O = 0 A;$ [1] _ ΔI_{CC} additional supply current 40 μΑ - $V_{CC} = 3.3 V$ pF Cı input capacitance $V_{CC} = 0$ V to 3.6 V; $V_I = GND$ or V_{CC} 0.6 -_ Co output capacitance $V_O = GND; V_{CC} = 0 V$ 1.3 pF --T_{amb} = -40 °C to +85 °C HIGH-level input voltage $V_{CC} = 0.8 V$ $0.70 \times V_{CC}$ -V VIH - $V_{CC} = 0.9 \text{ V}$ to 1.95 V $0.65 \times V_{CC}$ -V - $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ 1.6 _ _ V $V_{CC} = 3.0 \text{ V}$ to 3.6 V V 2.0 --VIL LOW-level input voltage $V_{CC} = 0.8 V$ $0.30 \times V_{CC}$ V - $V_{CC} = 0.9 V$ to 1.95 V $0.35 \times V_{CC}$ V _ - $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ 0.7 V -- $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ 0.9 V -- $V_I = V_{IH} \text{ or } V_{IL}$ VOH HIGH-level output voltage $I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 0.8 \ \text{V} \text{ to } 3.6 \ \text{V}$ $V_{CC} - 0.1$ V -_ $I_{O} = -1.1 \text{ mA}; V_{OO} = 1.1 \text{ V}$ $0.7 \times V_{CC}$ V -- $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ V 1.03 _ _ $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 1.30 V -- $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.97 V -- $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.85 V _ - $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.67 V -_ $I_{O} = -4.0 \text{ mA}; V_{OO} = 3.0 \text{ V}$ 2.55 V --LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ VOL V $I_{O} = 20 \ \mu A$; $V_{CC} = 0.8 \ V$ to 3.6 V 0.1 --I_O = 1.1 mA; V_{CC} = 1.1 V $0.3 \times V_{CC}$ V --V $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ _ -0.37 I_O = 1.9 mA; V_{CC} = 1.65 V 0.35 V _ - $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.33 V --I_O = 3.1 mA; V_{CC} = 2.3 V V 0.45 --I_O = 2.7 mA; V_{CC} = 3.0 V 0.33 V _ - $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.45 V -- $V_1 = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V I_I input leakage current --±0.5 μA power-off leakage current V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V **I**OFF _ _ ±0.5 μA $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ ΔI_{OFF} additional power-off ±0.6 μΑ _ _ leakage current $V_{CC} = 0 V \text{ to } 0.2 V$

Table 7. Static characteristics ...continued

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
l _{cc}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \; A; \\ V_{CC} = 0.8 \; V \; to \; 3.6 \; V \end{array}$		-	-	0.9	μΑ
∆I _{CC}	additional supply current		<u>[1]</u>	-	-	50	μΑ
T _{amb} = -4	40 °C to +125 °C						
VIH	HIGH-level input voltage	$V_{CC} = 0.8 V$		$0.75 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V		$0.70\times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V		1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	-	V
VIL	LOW-level input voltage	$V_{CC} = 0.8 V$		-	-	$0.25\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V		-	-	$0.30\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V		-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	-	0.9	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		I_O = –20 $\mu A; \ V_{CC}$ = 0.8 V to 3.6 V		$V_{CC}-0.11$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$		$0.6\times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$		0.93	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$		1.17	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$		1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$		1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$		2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$		2.30	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V		-	-	0.11	V
		I _O = 1.1 mA; V _{CC} = 1.1 V		-	-	$0.33 \times V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V		-	-	0.41	V
		I _O = 1.9 mA; V _{CC} = 1.65 V		-	-	0.39	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.36	V
		I _O = 3.1 mA; V _{CC} = 2.3 V		-	-	0.50	V
		I _O = 2.7 mA; V _{CC} = 3.0 V		-	-	0.36	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$		-	-	0.50	V
I.	input leakage current	$V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V		-	-	±0.75	μΑ
OFF	power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V		-	-	±0.75	μA
∆I _{OFF}	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$		-	-	±0.75	μA
сс	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \; A; \\ V_{CC} = 0.8 \; V \; to \; 3.6 \; V \end{array}$		-	-	1.4	μA
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	<u>[1]</u>	-	-	75	μΑ

Table 7. Static characteristics ...continued

[1] One input at V_{CC} – 0.6 V, other input at V_{CC} or GND.

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11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions	25 °C	;		–40 °C	C to +125 °	С	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 p	F							•	
pd	propagation delay	nA or nB to nY; see Figure 8	[2]						
		$V_{CC} = 0.8 V$	-	21.2	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.3	5.9	13.1	2.1	14.3	15.8	ns
		V_{CC} = 1.4 V to 1.6 V	1.8	4.1	7.7	1.6	8.8	9.7	ns
		V_{CC} = 1.65 V to 1.95 V	1.5	3.3	5.9	1.4	6.9	7.6	ns
		V_{CC} = 2.3 V to 2.7 V	1.2	2.6	4.4	1.1	5.3	5.9	ns
		V_{CC} = 3.0 V to 3.6 V	1.0	2.3	4.0	0.9	4.7	5.2	ns
C _L = 10	pF								
pd	propagation delay	nA or nB to nY; see Figure 8	[2]						
		$V_{CC} = 0.8 V$	-	24.7	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.6	6.8	14.8	2.4	16.2	17.9	ns
		V_{CC} = 1.4 V to 1.6 V	2.2	4.8	8.7	1.9	10.0	11.0	ns
		V_{CC} = 1.65 V to 1.95 V	1.8	3.9	6.7	1.7	8.0	8.8	ns
		V_{CC} = 2.3 V to 2.7 V	1.5	3.1	5.2	1.4	6.2	6.9	ns
		V_{CC} = 3.0 V to 3.6 V	1.3	2.9	4.8	1.3	5.6	6.2	ns
C _L = 15	pF								
pd	propagation delay	nA or nB to nY; see Figure 8	[2]						
		$V_{CC} = 0.8 V$	-	28.2	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.0	7.6	16.5	2.7	18.1	20.0	ns
		V_{CC} = 1.4 V to 1.6 V	2.4	5.3	9.6	2.2	11.3	12.5	ns
		V_{CC} = 1.65 V to 1.95 V	2.1	4.4	7.5	1.9	9.0	9.9	ns
		V_{CC} = 2.3 V to 2.7 V	1.8	3.6	5.9	1.6	7.0	7.7	ns
		V_{CC} = 3.0 V to 3.6 V	1.6	3.3	5.4	1.5	6.4	7.1	ns
C _L = 30	pF								
pd	propagation delay	nA or nB to nY; see Figure 8	[2]						
		$V_{CC} = 0.8 V$	-	38.5	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.9	9.9	21.5	3.5	24.1	26.6	ns
		V_{CC} = 1.4 V to 1.6 V	3.2	6.9	12.5	2.8	14.8	16.3	ns
		V_{CC} = 1.65 V to 1.95 V	2.8	5.7	9.8	2.5	11.7	12.9	ns
		V_{CC} = 2.3 V to 2.7 V	2.4	4.7	7.6	2.2	9.1	10.1	ns
		V _{CC} = 3.0 V to 3.6 V							

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Symbol	Parameter	Conditions	25 °C	25 °C		–40 °C	C to +125 °	С	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 p	F, 10 pF, 15 pF and	30 pF							
C _{PD}	power dissipation capacitance	f = 1 MHz; V_I = GND to V_{CC}	<u>[3]</u>						
		$V_{CC} = 0.8 V$	-	2.7	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	2.9	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	3.0	-	-	-	-	pF
		V _{CC} = 1.65 V to 1.95 V	-	3.1	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.6	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	4.2	-	-	-	-	pF

Table 8. Dynamic characteristics ... continued

-----0 1 A C

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{\mathsf{D}} = C_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times f_i \times \mathsf{N} + \Sigma(C_\mathsf{L} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms



Table 9. **Measurement points**

Supply voltage	Output	Input				
V _{cc}	V _M	V _M	VI	$t_r = t_f$		
0.8 V to 3.6 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{CC}	\leq 3.0 ns		

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Table 10. Test data

Supply voltage	Load	V _{EXT}			
V _{cc}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times $R_L = 5 k\Omega$.

For measuring propagation delays, set-up and hold times and pulse width R_L = 1 M Ω .

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13. Package outline



Fig 10. Package outline SOT765-1 (VSSOP8)

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Fig 11. Package outline SOT833-1 (XSON8)

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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 12. Package outline SOT1089 (XSON8)

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XSON8: plastic extremely thin small outline package; no leads; 8 terminals: body 3 x 2 x 0.5 mm

Fig 13. Package outline SOT996-2 (XSON8)

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XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

Fig 14. Package outline SOT902-2 (XQFN8)

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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

Fig 15. Package outline SOT1116 (XSON8)

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XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 16. Package outline SOT1203 (XSON8)

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14. Abbreviations

Table 11. Abbreviations		
Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	

15. Revision history

Table 12. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G86 v.8	20130124	Product data sheet	-	74AUP2G86 v.7
Modifications:	 For type nur 	nber 74AUP2G86GD XSON8L	I has changed to XS	ON8.
74AUP2G86 v.7	20120614	Product data sheet	-	74AUP2G86 v.6
74AUP2G86 v.6	20111208	Product data sheet	-	74AUP2G86 v.5
74AUP2G86 v.5	20100727	Product data sheet	-	74AUP2G86 v.4
74AUP2G86 v.4	20090629	Product data sheet	-	74AUP2G86 v.3
74AUP2G86 v.3	20090504	Product data sheet	-	74AUP2G86 v.2
74AUP2G86 v.2	20080319	Product data sheet	-	74AUP2G86 v.1
74AUP2G86 v.1	20061009	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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